

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	5	("20040145056"   "5050838"   "6020215"   "6162367"   "6706548").PN.	US-PGPUB; USPAT	ADJ	ON	2008/12/06 10:14
S2	16	((JOZEF) near2 ("VAN BEEK")).INV.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/12/06 10:15
S3	32	((JOZEF) near2 ("VAN BEEK")).INV.	EPO; JPO; DERWENT	ADJ	ON	2008/12/06 10:15
S4	5	((MATHIEU) near2 (ULENAERS)).INV.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/12/06 10:15
S5	5	((MATHIEU) near2 (ULENAERS)).INV.	EPO; JPO; DERWENT	ADJ	ON	2008/12/06 10:15
S6	11805	mems and fluori\$3	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 13:11
S7	781	mems and (fluori\$3 with layer with (remov\$3 or etch\$3 or sacrific\$4))	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 13:12
S8	0	S7 and "257".ccls.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 13:12
S9	173	S7 and "257".clas.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 13:12
S10	263	S7 and "438".clas.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 13:13
S11	47	(S9 or S10) and (mem or mems).ti.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 13:16
S13	16702	mems.ti.ab.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:33
S14	189856	silicon substrate	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:34
S16	509030	(insulat\$3 or etch\$5 or oxid\$5) layer	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:35
S17	457582	fluorine or fluoride or hf or hydrofluori\$3	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:35
S18	2162	S13 and S14	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:36

S19	1030	S18 and S16	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:36
S20	468	S19 and S17	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:36
S21	9760	(fluorine or fluoride or hf or hydrofluori\$3) same (dry near3 etch\$3)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:37
S22	66	S13 AND S14 AND S16 and S21	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:37
S23	14009	(fluorine or fluoride or hf or hydrofluori\$3) same (dry near3 etch\$3)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:39
S24	73	S13 AND S14 AND S16 and S23	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/07 17:39
S25	1009	257/417.ccls.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 10:22
S26	132	(mem or mems) and S25	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 10:25
S27	121	S26 and substrate	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 10:26
S28	1009	257/417.ccls.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 13:46
S29	132	(mem or mems) and S28	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 13:46
S30	83	S29 and silicon near3 substrate	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 13:46
S31	83	S29 and (silicon near3 substrate)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 13:46

S32	30	("5015850"   "5210714"   "5226321"   "5265470"   "5313835"   "5354985"   "5475318"   "5659195"   "5665253"   "5666190"   "5747804"   "5883387"   "5894090"   "5929497"   "5994750"   "6075585"   "6091125"   "6092423"   "6174820"   "6211532"   "6229190"   "6296779"   "6337027").PN. OR ("6580138").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/12/08 14:12
S33	76947	((etch stop) or oxide) near4 layer near4 substrate	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:15
S34	21291	S33 and metal oxide	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:15
S35	222251	hf56	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:16
S36	11009	"hfo.sub.2"	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:16
S37	2254	S33 and S36	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:16
S38	85240	(mem or mems)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:17
S39	2572	S33 and S38	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:17
S40	677	S39 and metal oxide	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:17
S41	65	S39 and S36	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:17
S42	1	("6809394").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/12/08 14:19
S43	61	"al.sub.3O.sub.3"	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:22
S44	0	S43 and S39	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/08 14:22
S45	1010	257/417.cds.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/09 09:31

S46	132	(mem or mems) and S45	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2008/12/09 09:31
S47	1	("20070222007").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/12/09 10:58
S48	1	("6621280").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/12/10 14:04
S49	14857	(silicon near3 substrate) and ("al.sub.2O.sub.3" or "HfO.sub.2" or "Zro. SUB.2" OR "TiO.sub.2")	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/23 09:44
S50	1222	S49 and etch stop	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/23 09:44
S51	2	(silicon near3 substrate) and (("al.sub.2O.sub.3" or "HfO.sub.2" or "Zro. SUB.2" OR "TiO.sub.2") near5 etch stop)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/23 09:50
S52	90	(silicon near3 substrate) and (("al.sub.2O.sub.3" or "HfO.sub.2" or "Zro. SUB.2" OR "TiO.sub.2") with etch stop)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/23 09:52
S53	3	("20020031711") or ("20020117752") or ("20030003641").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2009/02/24 09:03
S54	90363	mem or (micro adj electromechanic\$4)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 10:00
S55	90	(silicon near3 substrate) and (("al.sub.2O.sub.3" or "HfO.sub.2" or "Zro. SUB.2" OR "TiO.sub.2") with etch stop)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 10:00
S56	6	S54 and S55	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 10:00
S57	50802	sacrific\$7 near3 (film or layer or substrate or material)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:08
S58	647	S57 and "439".clas.	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:10
S59	45	S58 and (mems or bistable adj switch or voltage adj switch)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:10
S60	201	("al.sub.2O.sub.3" or "HfO.sub.2" or "Zro. SUB.2" OR "TiO.sub.2") with etch stop)	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:11

S61	0	S58 and S60	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:11
S62	647	S57 and S58	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:11
S63	44	S57 and S60	US-PGPUB; USPAT; JPO; DERWENT	ADJ	ON	2009/02/24 14:11
S64	13	("2001/0005631").URPN.	USPAT	ADJ	ON	2009/02/24 14:14

2/28/2009 9:36:50 AM

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